

FPC Connectors

EF-51 Series 0.5mm Pitch (SMT)



Features

- Our original front flip lock structure ensures multi pins products of high level contact reliability.
 - •The structure which relieves the load from the cover when the FPC is locked will prevent detachment or breakage of the cover.
 - •There are no restrictions to the direction in which the FPC can be laid.
- 2. By turning the cover, an FPC/FFC can be connected easily with only a small force.
- 3. Low profile of 2.5mm height when mounted.
- 4. A small area with a 4.9mm depth will contribute to a reduced PCB mounting area.
- 5. Convenient bottom contact design.
- 6. A mechanism to prevent FPCs from coming loose is provided.
- 7. Using the ZIF structure.
- 8. Supplied in the embossed taping with automatic mounter.

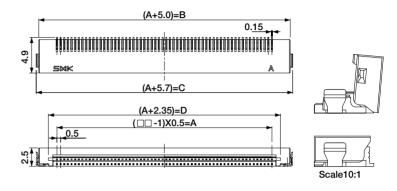
Specification

- 1. Rating: 0.5A, 50V AC/DC
- 2. Contact Resistance: 30mΩ, max., initially
- 3. Insulation Resistance: $100M\Omega$, min. at 100V DC
- 4. Withstanding Voltage: 100V AC (for one minute)
- 5. Operating Temperature Range: -40°C to +85°C

Material and Plating

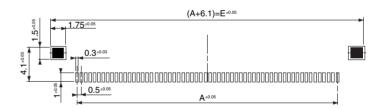
- Housing: Thermoplastic Resin, Natural Color, 94V-0
- Cover: Thermoplastic Resin, Black, 94V-0
- Contact: Cu Alloy, Au Plating
 Hold-down: Cu Alloy, Sn Plating

● CFP89 □ □-0350F — No. of Pins

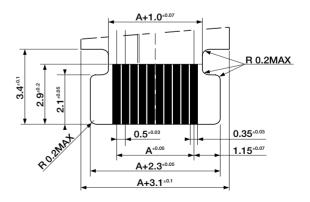


No. of Pins	Α	В	С	D	E
20	9.5	14.5	15.2	11.85	15.6
40	19.5	24.5	25.2	21.85	25.3
45	22.0	27.0	27.7	24.35	27.8
50	24.5	29.5	30.2	26.85	30.3
80	39.5	44.5	45.2	41.85	45.3

P.C. Board Dimension



Applicable FPC Dimension $(t=0.3\pm0.05)$



- •Please contact us for the 45 and 80 pins.
- FPC plating to recommend : Au plating